GL514/GL513F

■ Features

1. Output: **GL514** Φ e MIN. 3.31mW at

 $I_F = 100 \text{mA}$

GL513F Φ e MIN. 1.44mW at

 $I_F = 100 \text{mA}$

2. Beam angle : **GL514** $\Delta\theta$: TYP. \pm 7°

GL513F $\Delta\theta$: TYP. \pm 50

3. To- 18 type standard package

4. High reliability, long operation life

■ Applications

1. Optoelectronic switches

2. Smoke detectors

3. Infrared applied systems

■ Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Parameter	Symbol	Rating	Unit
Power dissipation	P	250	mW
Forward current	I_{F}	150	mA
*1Peak forward current	I _{FM}	2	A
Reverse voltage	V _R	6	V
Operating temperature	T opr	- 40 to + 125	°C
Storage temperature	T stg	- 55 to + 125	°C
*2Soldering temperature	T sol	260	°C

^{*1} Pulse width<= 200 \mu s

Duty ratio = 0.01

■ Electro-optical Characteristics

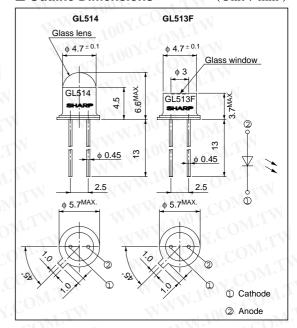
 $(Ta = 25^{\circ}C)$

Parar	neter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Forward voltage		V _F	$I_F = 100 \text{mA}$	CON	1.35	1.6	V
Peak forward voltage		V _{FM}	$I_{FM} = 1.5A$	-	2.75	4.0	V
Reverse current		I_R	$V_R = 5V$	47 GO		100	μΑ
Terminal capacitance		Ct	V = 0, $f = 1MHz$	C	70	-	pF
*3Radiant flux	GL514	Фе	$I_F = 100 \text{mA}$	3.31	5.35	10.0	mW
	GL513F			1.44	2.88	- 4 T	mW
Peak emission wavelength		λp	$I_F = 100 \text{mA}$	1001.	950	1.4.	nm
Half intensity wavelength		Δλ	$I_F = 100 \text{mA}$	Too V.	45	TEN	nm

TO-18 Type Infrared Emitting Diode

■ Outline Dimensions

(Unit: mm)



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^{*2} For 10 seconds at the position of 1.3mm from the bottom face of can package.

*3 Classification Table of Radiant Flux

Model No.	Rank Mark	$\Phi_{\rm e} ({\rm mW})$		
GL514A	A	5.35 to 10.0		
GL514	Jun Jun	3.31 to 10.0		

at $I_F = 100 \text{mA}$, $Ta = 25^{\circ}\text{C}$

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Fig. 1 Forward Current vs.

Ambient Temperature

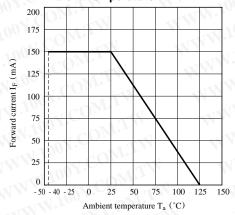


Fig. 3 Spectral Distribution

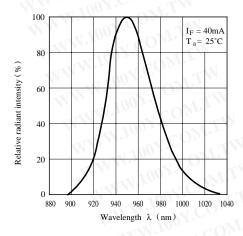


Fig. 2 Peak Forward Current vs. Duty Ratio

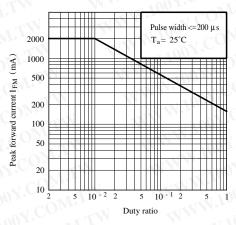


Fig. 4 Peak Emission Wavelength vs.
Ambient Temperature

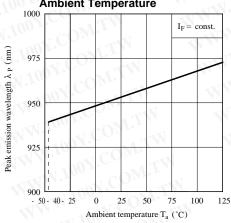


Fig. 5 Forward Current vs. Forward Voltage

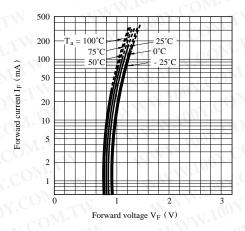


Fig. 7 Radiant Flux vs.

Forward Current (GL514)

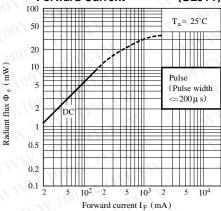
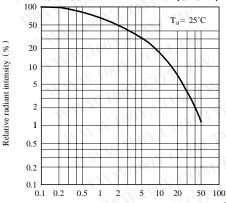


Fig. 9 Relative Radiant Intensity vs.
Distance (GL514)



Distance to detector d (mm)

Fig. 6 Relative Radiant Flux vs.
Ambient Temperature

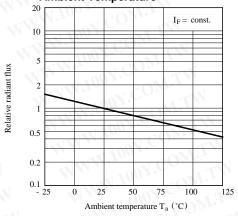


Fig. 8 Radiant Flux vs.

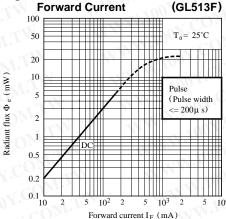
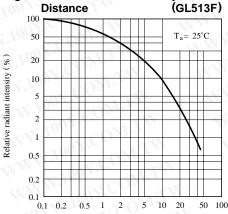


Fig.10 Relative Radiant Intensity vs.



Distance to detector d (mm)

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Fig.11 Radiation Diagram (GL514) $(T_a = 25^{\circ}C)$

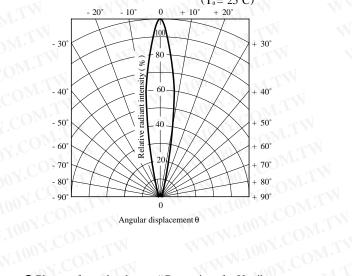
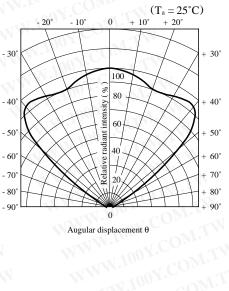


Fig.12 Radiation Diagram (GL513F)



Augular displacement θ

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• Please refer to the chapter "Precautions for Use."

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